



General-Purpose High-Voltage Open-Drain Output Dual Comparator

1 FEATURES

- Supply Range: +3.3V to +32V
- Low Supply Current
 55µA (TYP) per channel at V_S = 5V
- Common-Mode Input Voltage Range
 Includes Ground
- Low Output Saturation Voltage
- Open-Drain Output for Maximum Flexibility
- SPECIFIED UP TO +125°C
- Micro SIZE PACKAGES: SOP8、MSOP8

2 APPLICATIONS

- Hysteresis Comparators
- Factory Automation & Control
- Industrial Equipment
- Test and Measurement
- Cordless Power Tool
- Vacuum Robot
- Wireless Infrastructure

3 DESCRIPTIONS

The LM2903 is the dual comparator version, and the outputs can be connected to other open-collector outputs to achieve wired-AND relationships. It can operate from 3.3V to 32V, and have low power consuming $55\mu A$ (TYP) per channel.

The LM2903 consist of two independent voltage comparators that are designed to operate from a single power supply over a wide range of voltages. Quiescent current is independent of the supply voltage. The device is the most cost-effective solutions for applications where low offset voltage, high supply voltage capability, low supply current, and space saving are the primary specifications in circuit design for portable consumer products.

The LM2903 is available in Green SOP8, MSOP8 packages. It operates over an ambient temperature range of -40° C to $+125^{\circ}$ C.

Device information ("						
PART NUMBER	BODY SIZE (NOM)					
1 M2002	SOP8	4.90mm×3.90mm				
LM2903	MSOP8	3.00mm×3.00mm				

Device Information⁽¹⁾

 For all available packages, see the orderable addendum at the end of the data sheet.



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4 Revision History Note: Page numbers for previous revisions may different from page numbers in the current version.

VERSION	Change Date	Change Item
A.0	2020/11/5	Preview version completed
A.1	2021/03/27	Add MSOP-8 package
A.2	2022/03/09	 Increase the minimum junction temperature Legend added to TYPICAL CHARACTERISTICS Add TAPE AND REEL INFORMATION
A.3	2022/07/15	 Change Supply Range: +3.3V to +32V Change HBM ESD Ratings and Added MM ESD Ratings
A.3.1	2024/02/23	Modify packaging naming



5 PACKAGE/ORDERING INFORMATION ⁽¹⁾

Orderable Device	Package Type	Pin	Channel	Op Temp(°C)	Device Marking ⁽²⁾	Package Qty
LM2903XK	SOP8	8	2	-40°C ~+125°C	LM2903	Tape and Reel,4000
LM2903XM	MSOP8	8	2	-40°C ~+125°C	LM2903	Tape and Reel,4000

NOTE:

(1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.

(2) There may be additional marking, which relates to the lot trace code information(data code and vendor code), the logo or the environmental category on the device.



6 Pin Configuration and Functions (Top View)



Pin Description

NAME	PIN	I/O ⁽¹⁾	DESCRIPTION
	SOP8/MSOP8	1/0 (/	DESCRIPTION
OUTA	1	0	Output, channel A
-INA	2	I	Inverting input, channel A
+INA	3	I	Noninverting input, channel A
V-	4	Р	Negative (lowest) power supply
+INB	5	I	Noninverting input, channel B
-INB	6	I	Inverting input, channel B
OUTB	7	0	Output, channel B
V+	8	Р	Positive (highest) power supply

(1) I=Input, O=Output, P=Power

7 SPECIFICATIONS

7.1 Absolute Maximum Ratings

Over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

		MIN	MAX	UNIT
	Supply, V _S =(V+) - (V-)		36	
Voltage	Input pin (IN+, IN-) ⁽²⁾	(V-)-0.3	(V+) +0.3	V
	Signal output pin ⁽³⁾	(V-)-0.3	(V+) +0.3	
	Signal input pin (IN+, IN-) (2)	-10	10	mA
Current	Signal output pin ⁽³⁾	-55	55	mA
	Output short-circuits ⁽⁴⁾	Cont	inuous	
	Operating range, T _A	-40	125	
Temperature	Junction, T _J ⁽⁵⁾	-40	150	°C
	Storage, T _{stg}	-65	150	1

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) Input terminals are diode-clamped to the power-supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current-limited to 10mA or less.

(3) Output terminals are diode-clamped to the power-supply rails. Output signals that can swing more than 0.3V beyond the supply rails should be current-limited to ±55mA or less.

(4) Short-circuit from output to V_{CC} can cause excessive heating and eventual destruction.

(5) The maximum power dissipation is a function of $T_{J(MAX)}$, \tilde{R}_{0JA} , and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} - T_A) / R_{0JA}$. All numbers apply for packages soldered directly onto a PCB.

7.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

			VALUE	UNIT
		Human-Body Model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins ⁽¹⁾	±1000	
$V_{(\text{ESD})}$	Electrostatic discharge	Charged Device Model (CDM), per JEDEC specification JESD22-C101, all pins ⁽²⁾	±1000	V
		Machine Model (MM)	±400	

(1) JEDEC document JEP155 states that 500 V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250 V CDM allows safe manufacturing with a standard ESD control process.



ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

7.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage , Vs= (V+) - (V-)	Single-supply	3.3		32	V
	Dual-supply	±1.65		±16	v



7.4 Thermal Information: LM2903

		LM29	LM2903		
	THERMAL METRIC ⁽¹⁾	8PINS	8PINS	UNIT	
		SOP8	MSOP8		
Rəja	Junction-to-ambient thermal resistance	123.6	165	°C/W	
ReJC(top)	Junction-to-case(top) thermal resistance	70.5	53	°C/W	
Rөjb	Junction-to-board thermal resistance	66.7	87	°C/W	
Ψ_{JT}	Junction-to-top characterization parameter	23.5	4.9	°C/W	
ψ_{JB}	Junction-to-board characterization parameter	78.1	85	°C/W	
ReJC(bot)	Junction-to-case(bottom) thermal resistance	N/A	N/A	°C/W	

(1) Thermal resistance varies with operating conditions.



7.5 ELECTRICAL CHARACTERISTICS

(At T_A = +25°C, V_{CM}=(Vs/2), V_S=5V, unless otherwise noted.)

	DADAMETED				LM290	3	
	PARAMETER		CONDITIONS	MIN	TYP	MAX	UINTS
Vs	Operating Voltage Range			3.3		32	V
			Vs=5V, no load		110	180	
lα	Quiescent Current		V _S =32V, no load, T _A =-40°C to +125°C		150		uA
			Vs=5V to 32V	-3.5	±0.8	3.5	
Vos	Input offset voltage		V _S =5V to 32V T _A =-40°C to +125°C	-4		4	mV
IB	Input Diag Current		T _A =25°C		10	50	pА
ID	Input Bias Current		T _A =-40°C to +125°C			100	nA
			T _A =25°C		10	50	pА
los	Input Offset Current		T _A =-40°C to +125°C			100	nA
			Vs=3.3V to 32V	(V-)		(V+)-1.5	
Vсм	Common-Mode Voltage Rar	nge	V _S =3.3V to 32V T _A =-40°C to +125°C	(V-)		(V+)-2.0	V
A _{VD}	Large signal differential volta amplification	age	Vs=15V, Vo=1.4V to 11.4V R∟≥15k to (V+)	50	200		V/mV
Vol	Low-Level output voltage		I _{sink} ≤4mA, V _{ID} =-1V		200	300	mV
IOL	Output Current(sinking)		Vo=1.5V; VID=-1V; Vs=5V	6	23		mA
		0	(V+) =Vo=5V; V _{ID} =1V		80	400	nA
I _{OH-LKG}	High-Level Output Leakage	Current	(V+) =Vo=32V; V _{ID} =1V		100	500	nA
Switchir	ng Characteristics					•	
		Vs=5V	RPU=5.1KΩ, Overdrive =10mV		2.5		
Трнц	Propagation Delay H To L	VS=3V	RPU=5.1KΩ, Overdrive =100mV		0.5		
TENE		Vs=32V	RPU=5.1KΩ, Overdrive =10mV		1.8		
		v 3-02 v	RPU=5.1KΩ, Overdrive =100mV		0.7		us
		Vs=5V	RPU=5.1KΩ, Overdrive =10mV		4.1		
T _{PLH}	Propagation Delay L To H	v 3–0 v	RPU=5.1KΩ, Overdrive =100mV		1.6		
• PLH		Vs=32V	RPU=5.1KΩ, Overdrive =10mV		3.1		
		V 3-02 V	RPU=5.1KΩ, Overdrive =100mV		1.4		

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7.6 TYPICAL CHARACTERISTICS

NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.

At $T_A = +25^{\circ}C$, Vs=5V, R_{PULLUP}=5.1k, V_{CM} = Vs/2, C_L=15pF, unless otherwise noted.



Figure 1. Response Time vs Input Overdrives Negative Transition



Figure 3. Response Time vs Input Overdrives Negative Transition





Figure 2. Response Time vs Input Overdrives Positive Transition



Figure 4. Response Time vs Input Overdrives Positive Transition





8 Detailed Description

8.1 Overview

The LM2903 family of comparators can operate up to 32V on the supply pin. This standard device has proven ubiquity and versatility across a wide range of applications. This is due to its low power and high speed. The open-drain output allows the user to configure the output's logic low voltage (V_{OL}) and can be utilized to enable the comparator to be used in AND functionality.



Figure 7. Functional Block Diagram



9 Application and Implementation

Information in the following applications sections is not part of the RUNIC component specification, and RUNIC does not warrant its accuracy or completeness. RUNIC's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

LM2903 is typically used to compare a single signal to a reference or two signals against each other. Many users take advantage of the open drain output (logic high with pull-up) to drive the comparison logic output to a logic voltage level to an MCU or logic device. The wide supply range and high voltage capability makes this comparator optimal for level shifting to a higher or lower voltage.

9.2 Typical Application



Figure 8. Single-Ended and Differential Comparator Configurations

9.3 Detailed Design Procedure

When using the device in a general comparator application, determine the following:

- Input Voltage Range
- Minimum Overdrive Voltage
- Output and Drive Current
- Response Time

9.4 Input Voltage Range

When choosing the input voltage range, the input common mode voltage range (VICR) must be taken in to account. If temperature operation is below 25°C the VICR can range from 0 V to V_{CC}- 2.0 V. This limits the input voltage range to as high as V_{CC}- 2.0 V and as low as 0 V. Operation outside of this range can yield incorrect comparisons.



10 Layout

10.1 Layout Guidelines

For accurate comparator applications without hysteresis, it is important maintain a stable power supply with minimized noise and glitches. To achieve this, it is best to add a bypass capacitor between the supply voltage and ground. This should be implemented on the positive power supply and negative supply (if available). If a negative supply is not being used, do not put a capacitor between the IC's GND pin and system ground. Minimize coupling between outputs and inverting inputs to prevent output oscillations. Do not run output and inverting input traces in parallel unless there is a V_{CC} or GND trace between output and inverting input traces to reduce coupling. When series resistance is added to inputs, place resistor close to the device.

10.2 Layout Example



Figure 9. LM2903 Layout Example



11 PACKAGE OUTLINE DIMENSIONS SOP8





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol	Dimensions	n Millimeters	Dimensions In Inches		
Symbol	Min	Мах	Min	Max	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
с	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
е	1.270(BSC)		0.050	(BSC)	
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



MSOP8





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Мах	Min	Мах	
A	0.820	1.100	0.032	0.043	
A1	0.020	0.150	0.001	0.006	
A2	0.750	0.950	0.030	0.037	
b	0.250	0.380	0.010	0.015	
с	0.090	0.230	0.004	0.009	
D	2.900	3.100	0.114	0.122	
е	0.650(BSC)		0.026	(BSC)	
E	2.900	3.100	0.114	0.122	
E1	4.750	5.050	0.187	0.199	
L	0.400	0.800	0.016	0.031	
θ	0°	6°	0°	6°	

NOTE:

A. All linear dimension is in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.

D. BSC: Basic Dimension. Theoretically exact value shown without tolerances.



12 TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOP8	13"	12.4	6.40	5.40	2.10	4.0	8.0	2.0	12.0	Q1
MSOP8	13"	12.4	5.20	3.30	1.50	4.0	8.0	2.0	12.0	Q1

NOTE:

1. All dimensions are nominal.

2. Plastic or metal protrusions of 0.15mm maximum per side are not included.



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